Comprehensive Soldering 강의 계획서

Unit 1: Safety

Section 1.1: Common Safety Rules for Hand Soldering

Unit 2: ESD & Handling

Section 2.1: ESD Considerations Section 2.2: PCB Handling

Unit 3: Solder Preparation

Section 3.1: Soldering Iron Maintenance Section 3.2: Solder Tip Maintenance

Section 3.3: Tip Selection - Physical Size Section 3.4: Tip Selection - Temperature

Section 3.5: Solder Wire

Section 3.6: Melting Temperature of Solder

Section 3.7: Flux Introduction

Section 3.8: Flux Types

Section 3.9: Flux Core Percentage Section 3.10: Flux Summary Table

Unit 4: Soldering

Section 4.1: Creating the Solder Connection - Through Hole & Terminals

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Section 5.1: Cleaning - Flux Residue